

Atty. Dkt. No. 4100P9/CMP/CMP/RKK

**COMBINED DECLARATION AND POWER OF ATTORNEY**

As a below named inventor, I hereby declare that:

This declaration is of the following type:

- ☐ original  
☐ divisional  
☐ continuation  
☒ continuation-in-part

**INVENTORSHIP IDENTIFICATION**

My residence, post office address and citizenship are as stated below next to my name. I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

**PAD ASSEMBLY FOR ELECTROCHEMICAL MECHANICAL PROCESSING****SPECIFICATION IDENTIFICATION**

The specification of which:

- ☒ is attached hereto  
☐ was filed on \_\_\_\_\_, under Serial No. \_\_\_\_\_, executed on even date herewith; or  
☐ Express Mail No.(as Serial No. not yet known)  
and was amended on \_\_\_\_\_ (if applicable)  
☐ was described and claimed in PCT International Application No. \_\_\_\_\_  
filed on \_\_\_\_\_ and as amended under PCT Article 19 on \_\_\_\_\_

**ACKNOWLEDGMENT OF REVIEW OF PAPERS AND DUTY OF CANDOR**

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose all information I know to be material to patentability in accordance with Title 37, Code of Federal Regulations, §1.56, and which is material to the examination of this application; namely, information where there is a substantial likelihood that a reasonable Examiner would consider it important in deciding whether to allow the application to issue as a patent, and

- ☐ In compliance with this duty there is attached an Information Disclosure Statement in accordance with 37 CFR §1.98.

**PRIORITY CLAIM (35 U.S.C. §119)**

I hereby claim foreign priority benefits under Title 35, United States Code, §119, of any provisional or foreign application(s) for patent or inventor's certificate or of any PCT international application(s) designating at least one country other than the United States of America listed below, and have also identified below any provisional or foreign application(s) for patent or inventor's certificate or any PCT international application(s) designating at least one country other than the United States of America filed by me on the same subject matter having a filing date before that of the application(s) of which priority is claimed.

☒ No such applications have been filed.

☐ Such applications have been filed as follows:

- A. Prior foreign/PCT application(s) filed within 12 mos. (6 mos. for design) prior to this application, and any priority claims under 35 U.S.C. §119

Country/PCT

Application No

Date Filed

Priority Claimed

☐ Yes ☐ No  
☐ Yes ☐ No  
☐ Yes ☐ No

- B. All foreign application(s), if any, filed more than 12 mos. (6 mos for design) prior to this U.S. application

Country:

Application No:

Filing date:

- C. U.S. Provisional Application filed within 12 months prior to this application

Serial No.

Filing Date

**PRIORITY CLAIM (35 U.S.C. §120)**

I hereby claim the benefit under Title 35, United States Code, §120, of any United States application(s) or PCT international application(s) designating the United States of America that is/are listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in that/those prior application(s) in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose information that is material to the examination of this application (namely, information where there is substantial likelihood that a reasonable Examiner would consider it important in deciding whether to allow the application to issue as a patent) which occurred between the filing date of the prior application(s) and the national or PCT international filing date of this application.

☐

No such applications have been filed

☒

Such applications have been filed, as follows:

Serial No.	Filing Date	Status		
		Patented	Pending	Abandoned
10/642,128	August 15, 2003		X	
10/608,513	June 26, 2003		X	
10/140,010	May 7, 2002		X	
10/211,626	August 2, 2002		X	
10/033,732	December 27, 2001		X	
09/505,899	February 17, 2000	(ISSUED)		
10/210,972	August 2, 2002		X	
10/151,538	May 16, 2002		X	
10/244,697	September 16, 2002		X	
10/244,688	September 16, 2002		X	
10/391,324	March 18, 2003		X	

## POWER OF ATTORNEY

I hereby appoint the following attorneys and/or agents to prosecute this application and transact all business in the Patent and Trademark Office connected therewith:

Donald Verplancken	Registration No. 33,217
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Raymond Kam-On Kwong	Registration No. 37,165
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## DECLARATION

*I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and, further, that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Sec. 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.*

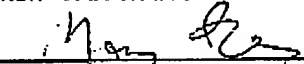
Full name of sole or first inventor: YONGQI HU

Inventor's signature: [Signature]Date: 12/01/2003Residence: 600 Marathon Drive #9  
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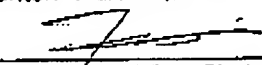
Country of Citizenship: China

Full name of second inventor: **STAN D. TSAI**Inventor's signature: Date: Dec. 1/03Residence: 5444 Dekker Terrace  
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Full name of third inventor: **YAN WANG**Inventor's signature: Date: Dec. 1/03Residence: 920 Rockefeller Drive #11B  
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Full name of fourth inventor: **FENG Q. LIU**Inventor's signature: Date: Dec. 01 03Residence: 4729 Lago Vista Circle  
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Full name of fifth inventor: **SHOU-SUNG CHANG**Inventor's signature: Date: Dec. 02, 2003Residence: P.O. Box 19462  
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Country of Citizenship: Taiwan

Full name of sixth inventor: **LIANG-YUH CHEN**Inventor's signature: Date: Dec. 01, 2003Residence: 1400 Melbourne Street  
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Country of Citizenship: Taiwan

(DECLARATION ENDS WITH THIS PAGE)

## UNITED STATES PATENT APPLICATION FOR:

PAD ASSEMBLY FOR ELECTROCHEMICAL  
MECHANICAL PROCESSING

## INVENTORS:

YONGQI HU  
STAN D. TSAI  
YAN WANG  
FENG Q. LIU  
SHOU-SUNG CHANG  
LIANG-YUH CHENCERTIFICATION OF MAILING UNDER 37 C.F.R. 1.10

I hereby certify that this New Application and the documents referred to as enclosed therein are being deposited with the United States Postal Service on 12-3-03, in an envelope marked as "Express Mail United States Postal Service", Mailing Label No. EV341109884US addressed to: Mail Stop PATENT APPLICATION, Commissioner for Patents, Box 1450, Alexandria, VA 22313-1450.

Signature

Name

Date of signature

DOCKET NO. 4100P9/CMP/CMP/RKK

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PATENT  
4100P9/CMP/CMP/RKK

## **PAD ASSEMBLY FOR ELECTROCHEMICAL MECHANICAL PROCESSING**

### **CROSS-REFERENCE TO RELATED APPLICATIONS**

[0001] This application is a continuation-in-part of co-pending United States Patent Application Serial No. 10/642,128, filed August 15, 2003 (hereinafter the '128 application). The '128 application is a continuation-in-part of co-pending United States Patent Application Serial No. 10/608,513, filed June 26, 2003 (hereinafter the '513 application), which is a continuation-in-part of co-pending United States Patent Application No. 10/140,010, filed May 7, 2002. The '513 application is also a continuation-in-part of co-pending United States Patent Application No. 10/211,626, filed August 2, 2002, which is a continuation-in-part of co-pending United States Patent Application No. 10/033,732, filed December 27, 2001, which is a continuation-in-part of United States Patent Application No. 09/505,899, filed February 17, 2000. The '513 application is additionally a continuation-in-part of co-pending United States Patent Application Serial No. 10/210,972, filed August 2, 2002, which is also a continuation-in-part of United States Patent Application No. 09/505,899, filed February 17, 2000. The '513 application is further continuation-in-part of co-pending United States Patent Application No. 10/151,538, filed May 16, 2002. The '128 application is also a continuation-in-part of co-pending United States Patent Application Serial No. 10/244,697, filed September 16, 2002, which is a continuation-in-part of United States Application Serial No. 10/244,688, filed September 16, 2002, and of co-pending United States Patent Application Serial No. 10/391,324, filed March 18, 2003. All of the above referenced applications are hereby incorporated by reference in their entireties.

[0002] This application is additionally related to United States Patent Application Serial No. 10/033,732, filed on December 27, 2001; United States Patent Application Serial No. 10/455,941, filed June 6, 2003; and United States Patent Application Serial No. 10,455,895, filed June 6, 2003, all of which are also incorporated herein by reference in their entireties.